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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	10MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	22
Program Memory Size	14KB (8K x 14)
Program Memory Type	ОТР
EEPROM Size	-
RAM Size	368 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 6V
Data Converters	A/D 5x8b
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c76-10-sp

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

TABLE 1-1: PIC16C7XX FAMILY OF DEVCES

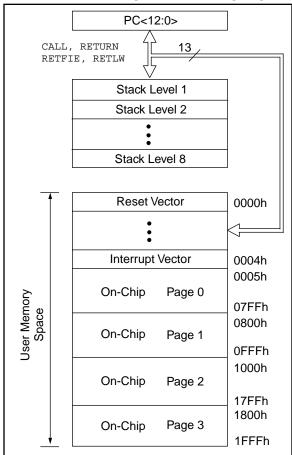
		PIC16C710	PIC16C71	PIC16C711	PIC16C715	PIC16C72	PIC16CR72 ⁽¹⁾
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20	20
	EPROM Program Memory (x14 words)	512	1K	1K	2K	2K	_
Memory	ROM Program Memory (14K words)	_	_	_	_	_	2K
	Data Memory (bytes)	36	36	68	128	128	128
	Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
Peripherals	Capture/Compare/ PWM Module(s)	_	_	_	_	1	1
	Serial Port(s) (SPI/I ² C, USART)	_	_	_	_	SPI/I ² C	SPI/I ² C
	Parallel Slave Port	_	_	_	_	_	_
	A/D Converter (8-bit) Channels	4	4	4	4	5	5
	Interrupt Sources	4	4	4	4	8	8
	I/O Pins	13	13	13	13	22	22
	Voltage Range (Volts)	3.0-6.0	3.0-6.0	3.0-6.0	3.0-5.5	2.5-6.0	3.0-5.5
Features	In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes	Yes
	Brown-out Reset	Yes	_	Yes	Yes	Yes	Yes
	Packages	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	28-pin SDIP, SOIC, SSOP	28-pin SDIP, SOIC, SSOP

		PIC16C73A	PIC16C74A	PIC16C76	PIC16C77
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20
Memory	EPROM Program Memory (x14 words)	4K	4K	8K	8K
	Data Memory (bytes)	192	192	368	368
	Timer Module(s)	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
Peripherals	Capture/Compare/PWM Mod- ule(s)	2	2	2	2
	Serial Port(s) (SPI/I ² C, US-ART)	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART
	Parallel Slave Port	_	Yes	_	Yes
	A/D Converter (8-bit) Channels	5	8	5	8
	Interrupt Sources	11	12	11	12
	I/O Pins	22	33	22	33
	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0
Features	In-Circuit Serial Programming	Yes	Yes	Yes	Yes
	Brown-out Reset	Yes	Yes	Yes	Yes
	Packages	28-pin SDIP, SOIC	40-pin DIP; 44-pin PLCC, MQFP, TQFP	28-pin SDIP, SOIC	40-pin DIP; 44-pin PLCC, MQFP, TQFP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C7XX Family devices use serial programming with clock pin RB6 and data pin RB7.

Note 1: Please contact your local Microchip sales office for availability of these devices.

FIGURE 4-3: PIC16C76/77 PROGRAM MEMORY MAP AND STACK



4.2 <u>Data Memory Organization</u>

Applicable Devices 72 | 73 | 73 | 74 | 74 | 76 | 77 |

The data memory is partitioned into multiple banks which contain the General Purpose Registers and the Special Function Registers. Bits RP1 and RP0 are the bank select bits.

RP1:RP0 (STATUS<6:5>)

= $00 \rightarrow Bank0$

= $01 \rightarrow Bank1$

= $10 \rightarrow Bank2$

= $11 \rightarrow Bank3$

Each bank extends up to 7Fh (128 bytes). The lower locations of each bank are reserved for the Special Function Registers. Above the Special Function Registers are General Purpose Registers, implemented as static RAM. All implemented banks contain special function registers. Some "high use" special function registers from one bank may be mirrored in another bank for code reduction and quicker access.

4.2.1 GENERAL PURPOSE REGISTER FILE

The register file can be accessed either directly, or indirectly through the File Select Register FSR (Section 4.5).

TABLE 4-1: PIC16C72 SPECIAL FUNCTION REGISTER SUMMARY (Cont.'d)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets (3)
Bank 1											
80h ⁽¹⁾	INDF	Addressing	this location	uses conten	ts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
81h	OPTION	RBPU	INTEDG	T0CS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h ⁽¹⁾	PCL	Program Co	ounter's (PC)		0000 0000	0000 0000					
83h ⁽¹⁾	STATUS	IRP ⁽⁴⁾	RP1 ⁽⁴⁾	RP0	ТО	PD	Z	DC	С	0001 1xxx	000q quuu
84h ⁽¹⁾	FSR	Indirect data	a memory ad	dress pointe	r	•	•	•		xxxx xxxx	uuuu uuuu
85h	TRISA	_	_	PORTA Dat	a Direction F	Register				11 1111	11 1111
86h	TRISB	PORTB Dat	ta Direction F	Register						1111 1111	1111 1111
87h	TRISC	PORTC Da	ta Direction F	Register						1111 1111	1111 1111
88h	_	Unimpleme	nted							_	_
89h	_	Unimpleme	nted							_	_
8Ah ^(1,2)	PCLATH	_	_	_	Write Buffer	r for the uppe	er 5 bits of th	e PC		0 0000	0 0000
8Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
8Ch	PIE1	_	ADIE	_	_	SSPIE	CCP1IE	TMR2IE	TMR1IE	-0 0000	-0 0000
8Dh	_	Unimpleme	nted			•	•	'	-	_	_
8Eh	PCON	_	_	_	_	_	_	POR	BOR	qq	uu
8Fh	_	Unimpleme	nted		•	•	'	'		_	_
90h	_	Unimpleme	nted							_	_
91h	_	Unimpleme	nted							_	_
92h	PR2	Timer2 Peri	iod Register							1111 1111	1111 1111
93h	SSPADD	Synchronou	us Serial Port	(I ² C mode)	Address Re	gister				0000 0000	0000 0000
94h	SSPSTAT	_	_	D/Ā	Р	S	R/W	UA	BF	00 0000	00 0000
95h	_	Unimpleme	nted		•	•	'	'		_	_
96h	_	Unimpleme	nted							_	_
97h	_	Unimpleme	nted							_	_
98h	_	Unimpleme	nted							_	_
99h	_	Unimpleme	nted							_	_
9Ah	_	Unimpleme	Inimplemented								_
9Bh	_	Unimpleme	nted		_	_					
9Ch	_	Unimpleme	nted		_	_					
9Dh	_	Unimpleme	nted		_	_					
9Eh	_	Unimpleme	nted		_	_					
9Fh	ADCON1	_	_	_	_	_	PCFG2	PCFG1	PCFG0	000	000

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented read as '0'. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from either bank.

- 3: Other (non power-up) resets include external reset through MCLR and Watchdog Timer Reset.
- 4: The IRP and RP1 bits are reserved on the PIC16C72, always maintain these bits clear.

^{2:} The upper byte of the program counter is not directly accessible. PCLATH is a holding register for the PC<12:8> whose contents are transferred to the upper byte of the program counter.

TABLE 4-3: PIC16C76/77 SPECIAL FUNCTION REGISTER SUMMARY (Cont.'d)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets (2)
Bank 2											•
100h ⁽⁴⁾	INDF	Addressing	egister)	0000 0000	0000 0000						
101h	TMR0	Timer0 mod	ule's registe	r						xxxx xxxx	uuuu uuuu
102h ⁽⁴⁾	PCL	Program Co	unter's (PC)	Least Signif	icant Byte					0000 0000	0000 0000
103h ⁽⁴⁾	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
104h ⁽⁴⁾	FSR	Indirect data	memory ad	dress pointe	r	•		•		xxxx xxxx	uuuu uuuu
105h	_	Unimplemen	nted							_	_
106h	PORTB	PORTB Dat	a Latch whe	n written: PC	RTB pins whe	n read				xxxx xxxx	uuuu uuuu
107h	_	Unimpleme	nted							_	_
108h	_	Unimplemer	nted							_	_
109h	_	Unimplemen	nted							_	_
10Ah ^(1,4)	PCLATH	_	_	_	Write Buffer fo	or the upper	5 bits of the I	Program Cou	ınter	0 0000	0 0000
10Bh ⁽⁴⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
10Ch- 10Fh	_	Unimplemen	nted							_	_
Bank 3											
180h ⁽⁴⁾	INDF	Addressing	this location	uses conten	ts of FSR to a	ddress data r	memory (not	a physical re	egister)	0000 0000	0000 0000
181h	OPTION	RBPU	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
182h ⁽⁴⁾	PCL	Program Co	unter's (PC)	Least Sign	ificant Byte					0000 0000	0000 0000
183h ⁽⁴⁾	STATUS	IRP	RP1	RP0	то	PD	Z	DC	С	0001 1xxx	000q quuu
184h ⁽⁴⁾	FSR	Indirect data	memory ad	dress pointe	r					xxxx xxxx	uuuu uuuu
185h	_	Unimplemen	nted							_	_
186h	TRISB	PORTB Dat	a Direction F	Register						1111 1111	1111 1111
187h	_	Unimpleme	nted							_	_
188h	_	Unimplemented								_	_
189h	_	Unimplemented								_	_
18Ah ^(1,4)	PCLATH	_	_	_	Write Buffer fo	or the upper	5 bits of the I	Program Cou	ınter	0 0000	0 0000
18Bh ⁽⁴⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
18Ch- 18Fh	_	Unimpleme	nted							_	_

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented read as '0'. Shaded locations are unimplemented, read as '0'.

- Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for the PC<12:8> whose contents are transferred to the upper byte of the program counter.
 - 2: Other (non power-up) resets include external reset through MCLR and Watchdog Timer Reset.
 - 3: Bits PSPIE and PSPIF are reserved on the PIC16C76, always maintain these bits clear.
 - 4: These registers can be addressed from any bank.
 - 5: PORTD and PORTE are not physically implemented on the PIC16C76, read as '0'.

PIC16C7X

NOTES:

5.0 I/O PORTS

Applicable Devices 72 73 73 A 74 74 A 76 77

Some pins for these I/O ports are multiplexed with an alternate function for the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

5.1 PORTA and TRISA Registers

Applicable Devices 72 73 73A 74 74A 76 77

PORTA is a 6-bit latch.

The RA4/T0CKI pin is a Schmitt Trigger input and an open drain output. All other RA port pins have TTL input levels and full CMOS output drivers. All pins have data direction bits (TRIS registers) which can configure these pins as output or input.

Setting a TRISA register bit puts the corresponding output driver in a hi-impedance mode. Clearing a bit in the TRISA register puts the contents of the output latch on the selected pin(s).

Reading the PORTA register reads the status of the pins whereas writing to it will write to the port latch. All write operations are read-modify-write operations. Therefore a write to a port implies that the port pins are read, this value is modified, and then written to the port data latch.

Pin RA4 is multiplexed with the Timer0 module clock input to become the RA4/T0CKI pin.

Other PORTA pins are multiplexed with analog inputs and analog VREF input. The operation of each pin is selected by clearing/setting the control bits in the ADCON1 register (A/D Control Register1).

Note: On a Power-on Reset, these pins are configured as analog inputs and read as '0'.

The TRISA register controls the direction of the RA pins, even when they are being used as analog inputs. The user must ensure the bits in the TRISA register are maintained set when using them as analog inputs.

EXAMPLE 5-1: INITIALIZING PORTA

```
BCF
       STATUS, RPO
BCF
       STATUS, RP1
                   ; PIC16C76/77 only
CLRF
       PORTA
                    ; Initialize PORTA by
                    ; clearing output
                    ; data latches
BSF
       STATUS, RPO
                    ; Select Bank 1
                    ; Value used to
MOVLW
                    ; initialize data
                    ; direction
MOVWE TRISA
                    ; Set RA<3:0> as inputs
                    ; RA<5:4> as outputs
                    ; TRISA<7:6> are always
                    ; read as '0'.
```

FIGURE 5-1: BLOCK DIAGRAM OF RA3:RA0 AND RA5 PINS

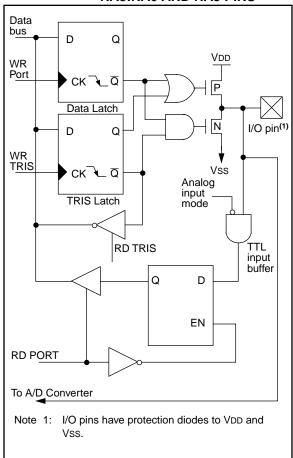
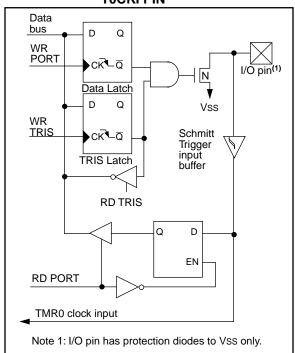


FIGURE 5-2: BLOCK DIAGRAM OF RA4/ TOCKI PIN



5.4 PORTD and TRISD Registers

Applicable Devices 72 73 73A 74 74A 76 77

PORTD is an 8-bit port with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

PORTD can be configured as an 8-bit wide microprocessor port (parallel slave port) by setting control bit PSPMODE (TRISE<4>). In this mode, the input buffers are TTL.

FIGURE 5-7: PORTD BLOCK DIAGRAM (IN I/O PORT MODE)

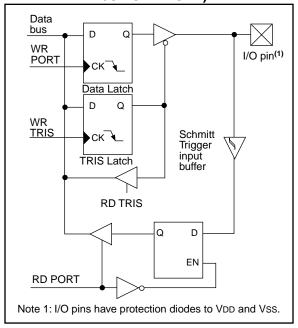


TABLE 5-7: PORTD FUNCTIONS

Name	Bit#	Buffer Type	Function
RD0/PSP0	bit0	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit0
RD1/PSP1	bit1	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit1
RD2/PSP2	bit2	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit2
RD3/PSP3	bit3	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit3
RD4/PSP4	bit4	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit4
RD5/PSP5	bit5	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit5
RD6/PSP6	bit6	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit6
RD7/PSP7	bit7	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit7

Legend: ST = Schmitt Trigger input TTL = TTL input

Note 1: Input buffers are Schmitt Triggers when in I/O mode and TTL buffer when in Parallel Slave Port Mode.

TABLE 5-8: SUMMARY OF REGISTERS ASSOCIATED WITH PORTD

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
08h	PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	xxxx xxxx	uuuu uuuu
88h	TRISD	PORT	D Data	Direction	on Register					1111 1111	1111 1111
89h	TRISE	IBF	OBF	IBOV	PSPMODE	_	PORTE Dat	a Direction B	0000 -111	0000 -111	

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used by PORTD.

8.1 <u>Timer1 Operation in Timer Mode</u>

Applicable Devices 72 | 73 | 73 A | 74 | 74 A | 76 | 77

Timer mode is selected by clearing the TMR1CS (T1CON<1>) bit. In this mode, the input clock to the timer is Fosc/4. The synchronize control bit $\overline{T1SYNC}$ (T1CON<2>) has no effect since the internal clock is always in sync.

8.2 <u>Timer1 Operation in Synchronized</u> Counter Mode

Applicable Devices 72 | 73 | 73 A | 74 | 74 A | 76 | 77

Counter mode is selected by setting bit TMR1CS. In this mode the timer increments on every rising edge of clock input on pin RC1/T1OSI/CCP2 when bit T1OSCEN is set or pin RC0/T1OSO/T1CKI when bit T1OSCEN is cleared.

If T1SYNC is cleared, then the external clock input is synchronized with internal phase clocks. The synchronization is done after the prescaler stage. The prescaler stage is an asynchronous ripple-counter.

In this configuration, during SLEEP mode, Timer1 will not increment even if the external clock is present, since the synchronization circuit is shut off. The prescaler however will continue to increment.

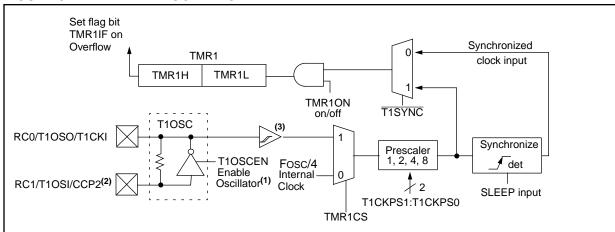
8.2.1 EXTERNAL CLOCK INPUT TIMING FOR SYNCHRONIZED COUNTER MODE

When an external clock input is used for Timer1 in synchronized counter mode, it must meet certain requirements. The external clock requirement is due to internal phase clock (Tosc) synchronization. Also, there is a delay in the actual incrementing of TMR1 after synchronization.

When the prescaler is 1:1, the external clock input is the same as the prescaler output. The synchronization of T1CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks. Therefore, it is necessary for T1CKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to the appropriate electrical specifications, parameters 45, 46, and 47.

When a prescaler other than 1:1 is used, the external clock input is divided by the asynchronous ripple-counter type prescaler so that the prescaler output is symmetrical. In order for the external clock to meet the sampling requirement, the ripple-counter must be taken into account. Therefore, it is necessary for T1CKI to have a period of at least 4Tosc (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on T1CKI high and low time is that they do not violate the minimum pulse width requirements of 10 ns). Refer to the appropriate electrical specifications, parameters 40, 42, 45, 46, and 47.

FIGURE 8-2: TIMER1 BLOCK DIAGRAM



- Note 1: When the T1OSCEN bit is cleared, the inverter and feedback resistor are turned off. This eliminates power drain.
 - 2: The CCP2 module is not implemented in the PIC16C72.
 - 3: For the PIC16C73 and PIC16C74, the Schmitt Trigger is not implemented in external clock mode.

14.2.3 EXTERNAL CRYSTAL OSCILLATOR CIRCUIT

Either a prepackaged oscillator can be used or a simple oscillator circuit with TTL gates can be built. Prepackaged oscillators provide a wide operating range and better stability. A well-designed crystal oscillator will provide good performance with TTL gates. Two types of crystal oscillator circuits can be used; one with series resonance, or one with parallel resonance.

Figure 14-5 shows implementation of a parallel resonant oscillator circuit. The circuit is designed to use the fundamental frequency of the crystal. The 74AS04 inverter performs the 180-degree phase shift that a parallel oscillator requires. The 4.7 k Ω resistor provides the negative feedback for stability. The 10 k Ω potentiometer biases the 74AS04 in the linear region. This could be used for external oscillator designs.

FIGURE 14-5: EXTERNAL PARALLEL RESONANT CRYSTAL OSCILLATOR CIRCUIT

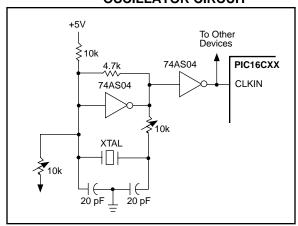
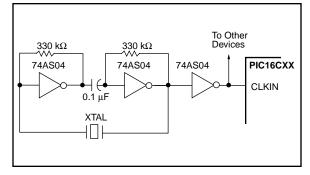


Figure 14-6 shows a series resonant oscillator circuit. This circuit is also designed to use the fundamental frequency of the crystal. The inverter performs a 180-degree phase shift in a series resonant oscillator circuit. The 330 k Ω resistors provide the negative feedback to bias the inverters in their linear region.

FIGURE 14-6: EXTERNAL SERIES
RESONANT CRYSTAL
OSCILLATOR CIRCUIT



14.2.4 RC OSCILLATOR

For timing insensitive applications the "RC" device option offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (Rext) and capacitor (Cext) values, and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low Cext values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 14-7 shows how the R/C combination is connected to the PIC16CXX. For Rext values below 2.2 k Ω , the oscillator operation may become unstable, or stop completely. For very high Rext values (e.g. 1 M Ω), the oscillator becomes sensitive to noise, humidity and leakage. Thus, we recommend to keep Rext between 3 k Ω and 100 k Ω .

Although the oscillator will operate with no external capacitor (Cext = 0 pF), we recommend using values above 20 pF for noise and stability reasons. With no or small external capacitance, the oscillation frequency can vary dramatically due to changes in external capacitances, such as PCB trace capacitance or package lead frame capacitance.

See characterization data for desired device for RC frequency variation from part to part due to normal process variation. The variation is larger for larger R (since leakage current variation will affect RC frequency more for large R) and for smaller C (since variation of input capacitance will affect RC frequency more).

See characterization data for desired device for variation of oscillator frequency due to VDD for given Rext/ Cext values as well as frequency variation due to operating temperature for given R, C, and VDD values.

The oscillator frequency, divided by 4, is available on the OSC2/CLKOUT pin, and can be used for test purposes or to synchronize other logic (see Figure 3-4 for waveform).

FIGURE 14-7: RC OSCILLATOR MODE

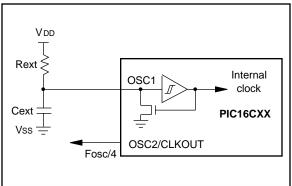


FIGURE 17-3: CLKOUT AND I/O TIMING

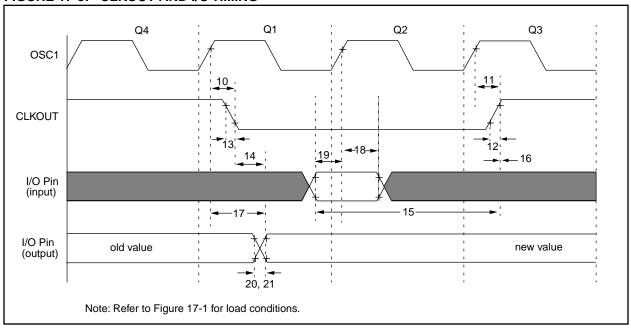


TABLE 17-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓		_	75	200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑		_	75	200	ns	Note 1
12*	TckR	CLKOUT rise time		_	35	100	ns	Note 1
13*	TckF	CLKOUT fall time		_	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid	d	_	_	0.5Tcy + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOL	JT ↑	Tosc + 200	_	_	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT	\uparrow	0	_	_	ns	Note 1
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid				150	ns	
18*	TosH2iol	OSC1↑ (Q2 cycle) to	PIC16 C 72	100	_	_	ns	
		Port input invalid (I/O in hold time)	PIC16 LC 72	200	_	_	ns	
19*	TioV2osH	Port input valid to OSC11	(I/O in setup time)	0	_	_	ns	
20*	TioR	Port output rise time	PIC16 C 72	_	10	40	ns	
			PIC16 LC 72	_	_	80	ns	
21*	TioF	Port output fall time	PIC16 C 72	_	10	40	ns	
			PIC16 LC 72	_	_	80	ns	
22††*	Tinp	INT pin high or low time	Tcy	_	_	ns		
23††*	Trbp	RB7:RB4 change INT high	or low time	Tcy	_	_	ns	

^{*} These parameters are characterized but not tested.

[†]Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

^{††} These parameters are asynchronous events not related to any internal clock edges.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

PIC16C7X

Applicable Devices 72 73 73A 74 74A 76 77

18.1 DC Characteristics: PIC16C73/74-04 (Commercial, Industrial)

PIC16C73/74-10 (Commercial, Industrial) PIC16C73/74-20 (Commercial, Industrial)

DC CHA	ARACTERISTICS		Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq \text{TA} \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq \text{TA} \leq +70^{\circ}\text{C}$ for commercial							
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions			
D001 D001A	Supply Voltage	VDD	4.0 4.5	-	6.0 5.5	V V	XT, RC and LP osc configuration HS osc configuration			
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V				
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details			
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details			
D010	Supply Current (Note 2,5)	IDD	-	2.7	5	mA	XT, RC osc configuration FOSC = 4 MHz, VDD = 5.5V (Note 4)			
D013			-	13.5	30	mA	HS osc configuration Fosc = 20 MHz, VDD = 5.5V			
D020 D021 D021A	Power-down Current (Note 3,5)	IPD	- - -	10.5 1.5 1.5	42 21 24	μΑ μΑ μΑ	VDD = $4.0V$, WDT enabled, -40° C to $+85^{\circ}$ C VDD = $4.0V$, WDT disabled, -0° C to $+70^{\circ}$ C VDD = $4.0V$, WDT disabled, -40° C to $+85^{\circ}$ C			

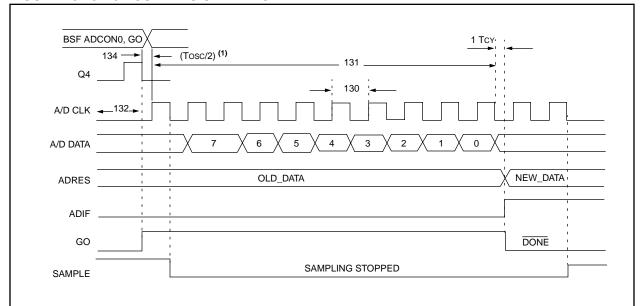
- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
 - The test conditions for all IDD measurements in active operation mode are:
 - OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD
 - MCLR = VDD; WDT enabled/disabled as specified.
 - 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
 - 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
 - 5: Timer1 oscillator (when enabled) adds approximately $20\,\mu\text{A}$ to the specification. This value is from characterization and is for design guidance only. This is not tested.

18.2 DC Characteristics: PIC16LC73/74-04 (Commercial, Industrial)

DC CHA	ARACTERISTICS			ard Ope	-		itions (unless otherwise stated) D°C ≤ TA ≤ +85°C for industrial and C ≤ TA ≤ +70°C for commercial
Param No.	Characteristic	Sym	Min	Тур†	Max		
D001	Supply Voltage	VDD	3.0	-	6.0	V	LP, XT, RC osc configuration (DC - 4 MHz)
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	٧	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details
D010	Supply Current (Note 2,5)	ldd	-	2.0	3.8	mA	XT, RC osc configuration FOSC = 4 MHz, VDD = 3.0V (Note 4)
D010A			-	22.5	48	μΑ	LP osc configuration Fosc = 32 kHz, VDD = 3.0V, WDT disabled
D020	Power-down Current	IPD	-	7.5	30	μΑ	VDD = 3.0V, WDT enabled, -40°C to +85°C
D021 D021A	(Note 3,5)		-	0.9 0.9	13.5 18	μA μA	VDD = 3.0V, WDT disabled, 0°C to +70°C VDD = 3.0V, WDT disabled, -40°C to +85°C

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
 - The test conditions for all IDD measurements in active operation mode are:
 - OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD
 - MCLR = VDD: WDT enabled/disabled as specified.
 - 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
 - 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
 - 5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.

FIGURE 18-13: A/D CONVERSION TIMING



Note 1: If the A/D clock source is selected as RC, a time of Tcy is added before the A/D clock starts. This allows the SLEEP instruction to be executed.

TABLE 18-14: A/D CONVERSION REQUIREMENTS

Param No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
130	TAD	A/D clock period	PIC16 C 73/74	1.6	_	_	μs	Tosc based, VREF ≥ 3.0V
			PIC16 LC 73/74	2.0	_	_	μs	Tosc based, VREF full range
			PIC16 C 73/74	2.0	4.0	6.0	μs	A/D RC Mode
			PIC16 LC 73/74	3.0	6.0	9.0	μs	A/D RC Mode
131	TCNV	Conversion time (not (Note 1)	including S/H time)	_	9.5	_	TAD	
132	TACQ	Acquisition time		Note 2	20	_	μs	
				5*	_	_	μs	The minimum time is the amplifier settling time. This may be used if the "new" input voltage has not changed by more than 1 LSb (i.e., 20 mV @ 5.12V) from the last sampled voltage (as stated on CHOLD).
134	Tgo	Q4 to A/D clock start		_	Tosc/2 §	_	_	If the A/D clock source is selected as RC, a time of Tcy is added before the A/D clock starts. This allows the SLEEP instruction to be executed.
135	Tswc	Switching from conve	rt → sample time	1.5 §	_	_	TAD	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

[§] This specification ensured by design.

Note 1: ADRES register may be read on the following TcY cycle.

^{2:} See Section 13.1 for min conditions.

FIGURE 19-7: CAPTURE/COMPARE/PWM TIMINGS (CCP1 AND CCP2)

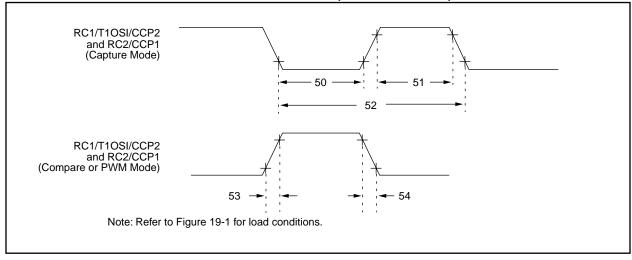


TABLE 19-6: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1 AND CCP2)

Param No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
50*	TccL	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	_	_	ns	
		input low time		PIC16 C 73A/74A	10	_	_	ns	
			With Prescaler	PIC16 LC 73A/74A	20	_	_	ns	
51*	TccH	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	_	_	ns	
		input high time	Maria B	PIC16 C 73A/74A	10	_	_	ns	
			With Prescaler	PIC16 LC 73A/74A	20	_	_	ns	
52*	TccP	CCP1 and CCP2 in	nput period		3Tcy + 40 N		_	ns	N = prescale value (1,4 or 16)
53*	TccR	CCP1 and CCP2 of	output rise time	PIC16 C 73A/74A	_	10	25	ns	
				PIC16 LC 73A/74A	_	25	45	ns	
54*	TccF	CCP1 and CCP2 of	ritput fall time PIC16 C 73A/74A		_	10	25	ns	
				PIC16 LC 73A/74A	_	25	45	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated.

These parameters are for design guidance only and are not tested.

FIGURE 19-12: USART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

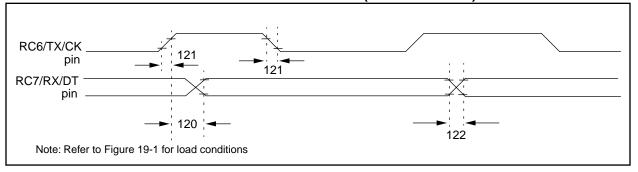


TABLE 19-11: USART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions	
120	TckH2dtV	SYNC XMIT (MASTER & SLAVE) Clock high to data out valid	PIC16 C 73A/74A PIC16 LC 73A/74A	_	_	80 100	ns ns	
121	Tckrf	Clock out rise time and fall time		_		45	ns	
122	Tdtrf	(Master Mode) Data out rise time and fall time	PIC16 LC 73A/74A PIC16 C 73A/74A	_ _	<u> </u>	50 45	ns ns	
			PIC16 LC 73A/74A	_	_	50	ns	

^{†:} Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 19-13: USART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

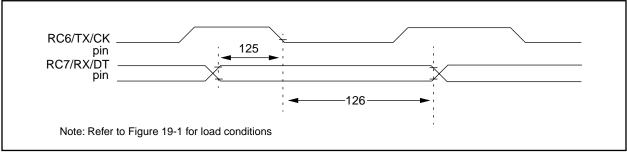


TABLE 19-12: USART SYNCHRONOUS RECEIVE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
125	TdtV2ckL	SYNC RCV (MASTER & SLAVE) Data setup before CK ↓ (DT setup time)	15			ns	
126	TckL2dtl	Data hold after CK ↓ (DT hold time)	15	_	_	ns	

^{†:} Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 20-7: CAPTURE/COMPARE/PWM TIMINGS (CCP1 AND CCP2)

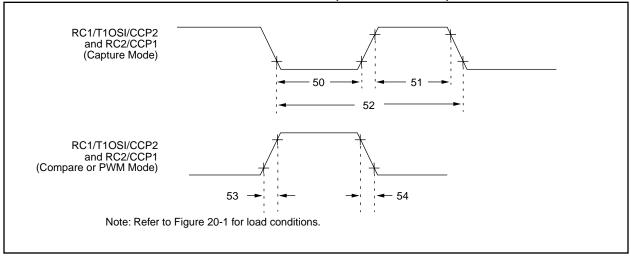


TABLE 20-6: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1 AND CCP2)

Param No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
50*	TccL	CCP1 and CCP2 input low time	No Prescaler		0.5Tcy + 20	_	_	ns	
			With Prescaler	PIC16 C 76/77	10	_	_	ns	
				PIC16 LC 76/77	20	_	_	ns	
51*	51* TccH	CCP1 and CCP2 input high time	No Prescaler		0.5Tcy + 20	_		ns	
			With Prescaler	PIC16 C 76/77	10	_	_	ns	
				PIC16 LC 76/77	20	_	_	ns	
52*	TccP	CCP1 and CCP2 input period			3Tcy + 40 N	_	_	ns	N = prescale value (1,4 or 16)
53*	53* TccR CCP1 and CCP2 output rise time		output rise time	PIC16 C 76/77	_	10	25	ns	
				PIC16 LC 76/77	_	25	45	ns	
54*	TccF	CCP1 and CCP2 output fall time		PIC16 C 76/77	_	10	25	ns	
				PIC16 LC 76/77	_	25	45	ns	

These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated.

These parameters are for design guidance only and are not tested.

FIGURE 21-29: TYPICAL IDD vs. FREQUENCY (HS MODE, 25°C)

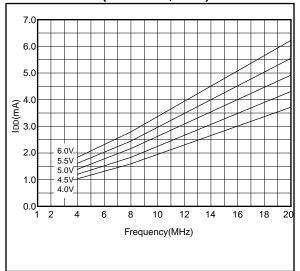
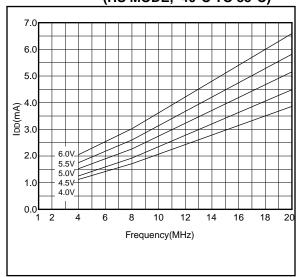
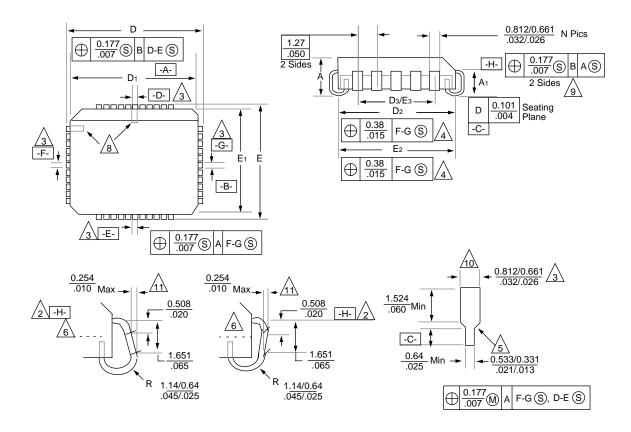


FIGURE 21-30: MAXIMUM IDD vs. FREQUENCY (HS MODE, -40°C TO 85°C)



22.7 44-Lead Plastic Leaded Chip Carrier (Square)(PLCC)



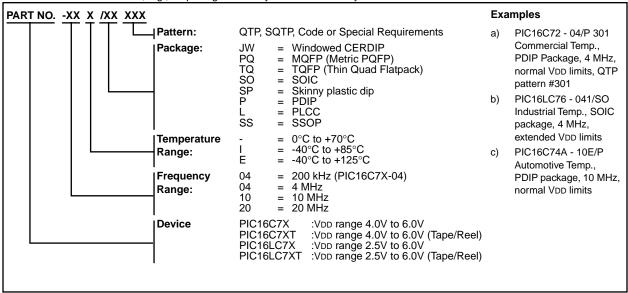
Package Group: Plastic Leaded Chip Carrier (PLCC)								
	Millimeters			Inches				
Symbol	Min	Max	Notes	Min	Max	Notes		
Α	4.191	4.572		0.165	0.180			
A1	2.413	2.921		0.095	0.115			
D	17.399	17.653		0.685	0.695			
D1	16.510	16.663		0.650	0.656			
D2	15.494	16.002		0.610	0.630			
D3	12.700	12.700	Reference	0.500	0.500	Reference		
Е	17.399	17.653		0.685	0.695			
E1	16.510	16.663		0.650	0.656			
E2	15.494	16.002		0.610	0.630			
E3	12.700	12.700	Reference	0.500	0.500	Reference		
N	44	44		44	44			
CP	_	0.102		_	0.004			
LT	0.203	0.381		0.008	0.015			

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PIC16C7X PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery refer to the factory or the listed sales office.



^{*} JW Devices are UV erasable and can be programmed to any device configuration. JW Devices meet the electrical requirement of each oscillator type (including LC devices).

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